

Phase Control Thyristors (Stud Version), 230 A



PRIMARY CHARACTERISTICS				
I _{T(AV)}	230 A			
V_{DRM}/V_{RRM}	400 V, 1800 V, 200 V			
V_{TM}	1.55 V			
I _{GT}	150 mA			
TJ	-40 °C to +125 °C			
Package	TO-93 (TO-209AB)			
Circuit configuration	Single SCR			

FEATURES

- · Center amplifying gate
- International standard case TO-93 (TO-209AB)



- Glass-metal seal up to 1200 V
- Compression bonded encapsulation for heavy duty operations such as severe thermal cycling
- · Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

- · DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
1		230	А		
I _{T(AV)}	T _C	85	°C		
I _{T(RMS)}		360	A		
	50 Hz	5700	۸		
I _{TSM}	60 Hz	5970	A		
I ² t	50 Hz	163	kA ² s		
1-1	60 Hz	149	KA-S		
V _{DRM} /V _{RRM}		400 to 1200	V		
tq	Typical	100	μs		
T _J		-40 to 125	°C		

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	I_{DRM}/I_{RRM} MAXIMUM AT $T_J = T_J$ MAXIMUM mA				
	04	400	500					
VS-ST230S	08	800	900	30				
	12	1200	1300					



ABSOLUTE MAXIMUM RATINGS	S					
PARAMETER	SYMBOL		TEST CON	IDITIONS	VALUES	UNITS
Maximum average on-state current		100° aandu	ation half sing.		230	Α
at case temperature	$I_{T(AV)}$	160 Condu	ction, half sine v	wave	85	°C
Maximum RMS on-state current	I _{T(RMS)}	DC at 78 °C	case temperati	ure	360	
		t = 10 ms	No voltage		5700	
Maximum peak, one-cycle	I	t = 8.3 ms	reapplied		5970	Α
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		4800	
		t = 8.3 ms	reapplied	Sinusoidal half wave, initial $T_J = T_J$ maximum	5000]
Maximum I ² t for fusing	l ² t	t = 10 ms	No voltage		163	- kA ² s
		t = 8.3 ms	reapplied		148	
Waxiiiuiiii tioi lusiiig		t = 10 ms	100 % V _{RRM}		115	
		t = 8.3 ms	reapplied		105	
Maximum I ² √t for fusing	I²√t	t = 0.1 to 10	t = 0.1 to 10 ms, no voltage reapplied		1630	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x \mid_{T(AV)} < I < \pi x$	$I_{T(AV)}$), $T_J = T_J$ maximum	0.92	V
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		0.98	V
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π x I _{T(AV)} < I < π x I _{T(AV)}), T _J = T _J maximum		0.88	mΩ	
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$ 0.8		0.81	11152	
Maximum on-state voltage	V_{TM}	$I_{pk} = 720 \text{ A}, T_J = T_J \text{ maximum}, t_p = 10 \text{ ms sine pulse}$ 1.55		V		
Maximum holding current	I _H	T _{.I} = 25 °C, anode supply 12 V resistive load		600	mA	
Maximum (typical) latching current	IL	1J = 23 0, alloue supply 12 v resistive load 1000 (30		1000 (300)	111/2	

SWITCHING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 Ω , $t_r \le 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\le 80~\%~V_{DRM}$	1000	A/µs	
Typical delay time	t _d	Gate current 1 A, $dl_g/dt = 1 A/\mu s$ $V_d = 0.67 \% V_{DRM}, T_J = 25 °C$	1.0		
Typical turn-off time	t _q	$I_{TM} = 300 \text{ A, } T_J = T_J \text{ maximum, } dI_F/dt = 20 \text{ A/}\mu\text{s,}$ $V_R = 50 \text{ V, } dV/dt = 20 \text{ V/}\mu\text{s, } \text{gate } 0 \text{ V } 100 \Omega, t_p = 500 \mu\text{s}$	100	μs	

BLOCKING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum critical rate of rise of off-state voltage	dV/dt	T _J = T _J maximum linear to 80 % rated V _{DRM}	500	V/µs	
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	30	mA	



TRIGGERING						
PARAMETER	SYMBOL	-	TEST COMPLETIONS		VALUES	
PARAMETER	STIVIBUL	•	EST CONDITIONS	TYP.	MAX.	UNITS
Maximum peak gate power	P_{GM}	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	10	0.0	W
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	VV
Maximum peak positive gate current	I _{GM}	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	3.	.0	Α
Maximum peak positive gate voltage	+V _{GM}	$T_J = T_J$ maximum, $t_p \le 5$ ms $\frac{20}{5.0}$		0	V	
Maximum peak negative gate voltage	-V _{GM}			5.0		
	I _{GT}	T _J = - 40 °C	Maximum required gate trigger/current/voltage are the lowest value which will trigger all units 12	180	-	
DC gate current required to trigger		T _J = 25 °C		90	150	mA
		T _J = 125 °C		40	-	
		T _J = - 40 °C		2.9	-	
DC gate voltage required to trigger	V _{GT}	T _J = 25 °C	V anode to cathode applied	1.8	3.0	V
		T _J = 125 °C		1.2	-	
DC gate current not to trigger	I _{GD}	T. T. massimum	Maximum gate current/voltage not to trigger is the maximum value which will not trigger any unit with rated V _{DRM} anode to cathode applied) 10		mA
DC gate voltage not to trigger	V _{GD}	$T_J = T_J \text{ maximum}$		0.:	25	٧

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum operating junction temperature range	TJ	TJ		°C	
Maximum storage temperature range	T _{Stg}		-40 to 150		
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	0.10	K/W	
Maximum thermal resistance, case to heatsink	R _{thC-hs}	Mounting surface, smooth, flat and greased	0.04		
Non-lubricated threads		Non-lubricated threads	31 (275)	N · m	
Mounting torque, ± 10 %		Lubricated threads	24.5 (210)	(lbf · in)	
Approximate weight			280	g	
Case style		See dimensions - link at the end of datasheet	TO-93 (TO-209AB)		

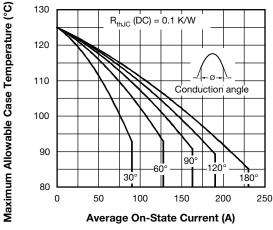
△R _{thJC} CONDUCTION						
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS		
180°	0.016	0.012				
120°	0.019	0.020				
90°	0.025	0.027	$T_J = T_J$ maximum	K/W		
60°	0.036	0.037				
30°	0.060	0.060				

Note

• The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

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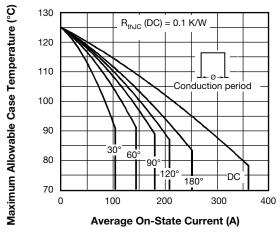


Fig. 2 - Current Ratings Characteristics

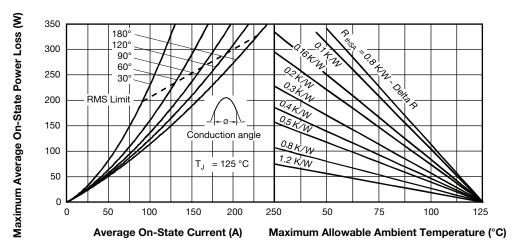


Fig. 3 - On-State Power Loss Characteristics

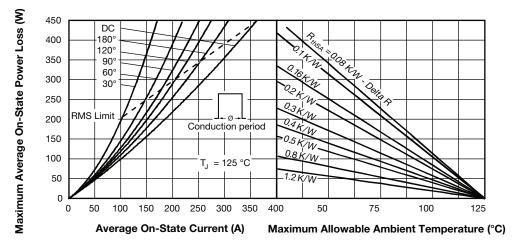


Fig. 4 - On-State Power Loss Characteristics

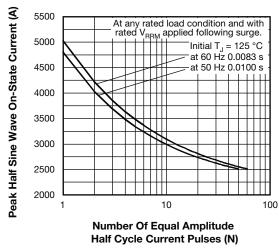


Fig. 5 - Maximum Non-Repetitive Surge Current

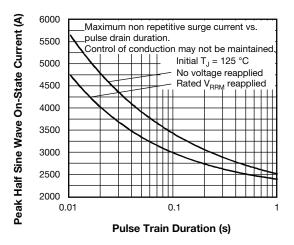


Fig. 6 - Maximum Non-Repetitive Surge Current

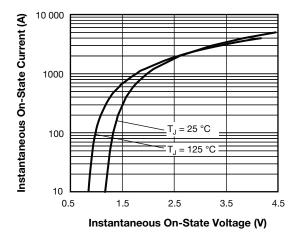


Fig. 7 - On-State Voltage Drop Characteristics

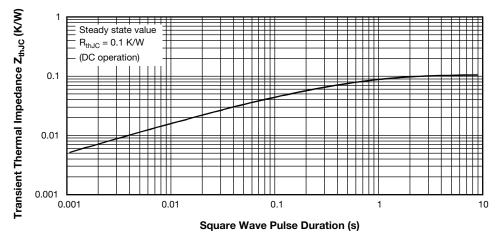


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics

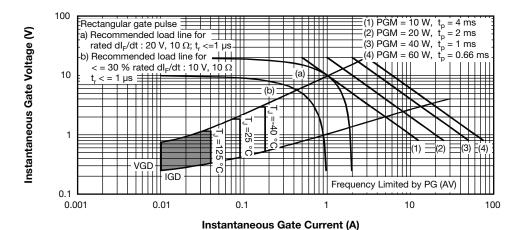
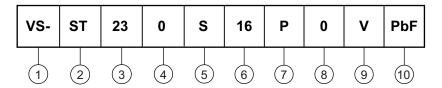


Fig. 9 - Gate Characteristics

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Thyristor

3 - Essential part number

- 0 = converter grade

5 - S = compression bonding stud

6 - Voltage code x 100 = V_{RRM} (see Voltage Ratings table)

P = stud base 3/4"-16UNF2A threads

0 = eyelet terminals (gate and auxiliary cathode leads)

1 = fast-on terminals (gate and auxiliary cathode leads)

9 - V = glass-metal seal (only up to 1200 V)

10 - None = standard production

- PbF = lead (Pb)-free

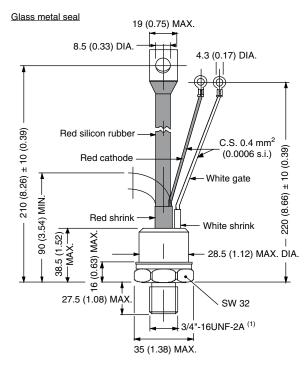
Note: For metric device M16 x 1.5 contact factory

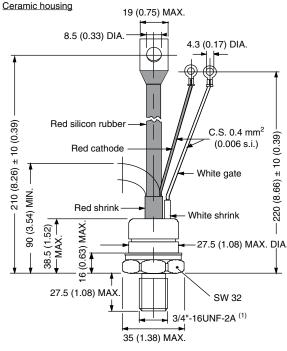
LINKS TO RELATED DOCUMENTS			
Dimensions	www.vishay.com/doc?95082		

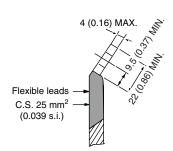


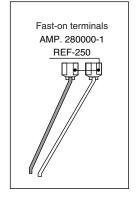
TO-209AB (TO-93)

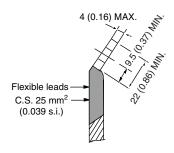
DIMENSIONS in millimeters (inches)











Note

(1) For metric device: M16 x 1.5 - length 21 (0.83) maximum



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